



Company History

2013 • Established in Dongtan, Korea Dealership with Singapore Global Foundries

Registered as a MCA repair vendor for Micron Singapore ISO 9001 & 14001 certification
Established new manufacturing factory & clean room

2015 Started LAM ESC repair business with TSMC and UMC in Taiwan Acquired R&D department certification

Acquired a patent on ESC for Semiconductor assembly

Awarded from KITA (Korea International Trade Association) for US \$1M Trade Awards

Registered as a vendor for On Semiconductor
Registered as a repair vendor for SMIC, XMC, CSMC (China)
Registered as a vendor for DB Hitek
Awarded from Governor in Gyeonggi province for "The Best Venture Company"

2018 • Certified a "Promising Export Small and Medium Enterprise" by Ministry of SML

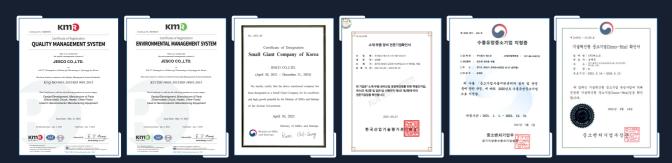
Qualification of Lam ESC and MCA repair in Toshiba
Registered as a vendor for SK Hynix
Registered as a vendor for TSMC

2020 Company relocation to Geumgok-dong

Awarded from KITA (Korea International Trade Association) for US \$3M Trade Awards

2021 • Registered as a vendor for SAMSUNG
Certified as Small Giant Company of Korea
Certified as Inno-Biz Company

Certificate



Management Ideology



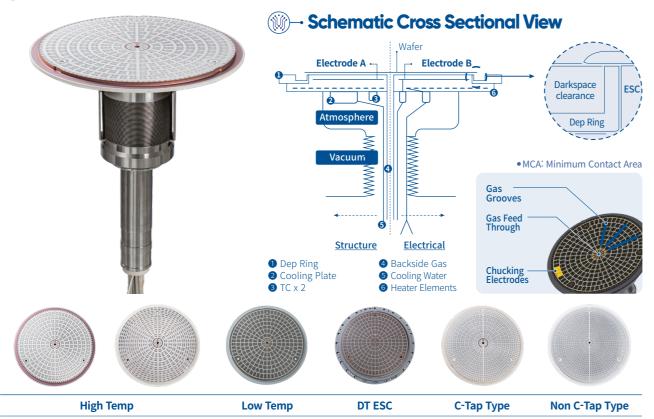
- Collaboration and Love, company culture of respect for employees
- Leading the global market in the value of core technologies
- **●** 100% of customer quality satisfaction





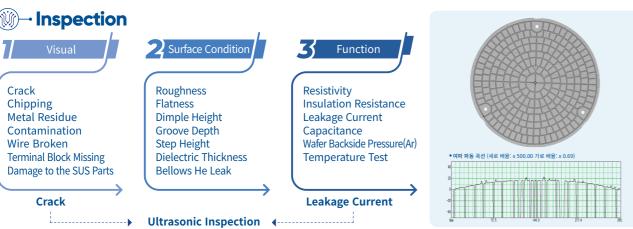
ENDURA MCA ESC

MCA Repair





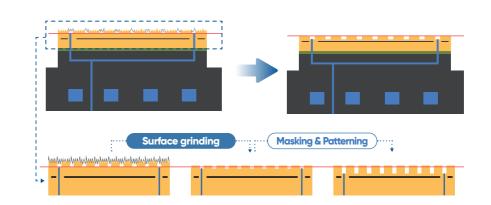




ESC (Electrostatic Chuck)

IN→**ESC Repair**





Repair	Description	Issue	
Level 1	Surface retreatment	Surface roughness or flatness issue	
Level 2	Level 1 + Re-bonding	Bonding layer	
Level 3	Level 1 + Plate exchange	Crack or chipping on the ceramic plate	
Level 4	Level 3 + Heater plate exchange	Damage on the heater plate	



-ESC OPM New



Blue Glass Coating ESC



ESC New

Super-E / E-max 8"

• AlN Plate: Same physical properties with OEM part

ITEM	UNIT	ОЕМ	JESCO	REMARK
Ceramic Puck	-	AlN	AlN	
Purity	%	≥99.9	≥99.9	
Volume Resistivity	Ω.cm	10 ¹⁰ ~ 10 ¹²	10 ¹⁰ ~ 10 ¹²	@500V
Thermal Conductivity	W/mK	90	90	@RT
Density	g/cm³	3.26	3.26	
Bonding Material	-	Same with OEM		



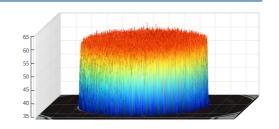
6series L4 / L0

ltem	L374	L608	L611	L620	L632	
Repair Scope	L0/L1/L2/L3/L4	L0/L1/L2/L3/L4	L0/L1/L2/L3/L4	L0/L1/L2/L3/L4	L1/L2/L4	
Part Number	839-019090-374	839-019090-608	839-019090-611	839-019090-620	839-019090-632	
Ceramic Material	OEM Al2O3 94%, JESCO Al2O3 96%					
Printing Layer	Single	Single	Single	Single	Multi	
Heater Zone	2 Zone	4 Zone	4 Zone	4 Zone	4 Zone	
Plate Size	Ф 295.25 Ф 295.75			Ф 297.88		
Embossing Size		Ф 0.25		Ф 1.0	Ф 1.5	
Silicone Bonding(Heater)	Same Method					









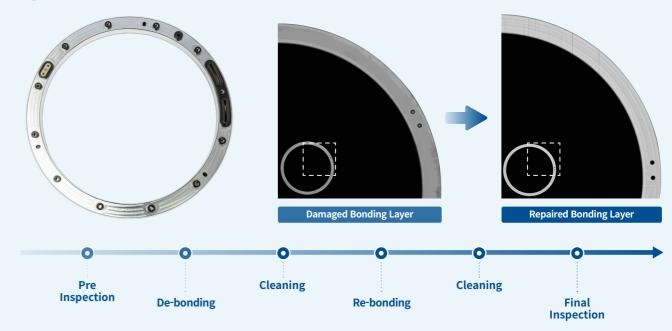
₩→Ultima 8"/12"





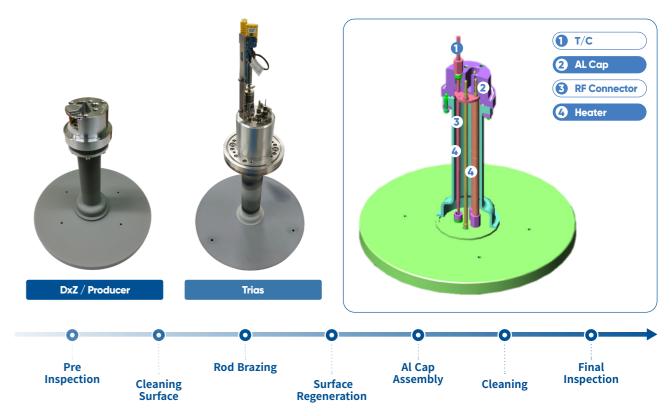
Heater Ring

├ Heater Ring Repair



AIN Heater

➢→AIN Heater Repair



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